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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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FDD6030L

March 2015



30V N-Channel PowerTrench^o MOSFET

General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on state resistance and yet maintain low gate charge for superior switching performance.

Applications

- DC/DC converter
- Motor Drives

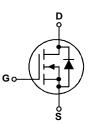
Features

• 12 A, 30 V
$$R_{DS(ON)} = 14.5 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$$

 $R_{DS(ON)} = 21 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$

- Low gate charge
- Fast Switching Speed
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$





Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Para	meter		Ratings	Units
V _{DSS}	Drain-Source Voltage			30	V
V _{GSS}	Gate-Source Voltage			±20	V
I _D	Continuous Drain Current	@T _c =25°C	(Note 3)	50	А
		@T _A =25°C	(Note 1a)	12	
		Pulsed	(Note 1a)	100	
PD	Power Dissipation	@T _c =25°C	(Note 3)	56	W
		@T _A =25°C	(Note 1a)	3.2	
		@T _A =25°C	(Note 1b)	1.5	
T_{J}, T_{STG}	Operating and Storage Ju	nction Temperatu	ire Range	-55 to +175	°C
Therma	I Characteristics				
$R_{\theta JC}$	Thermal Resistance, Junc	tion-to-Case	(Note 1)	2.7	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junc	tion-to-Ambient	(Note 1a)	45	
$R_{\theta JA}$			(Note 1b)	96	

Package Marking and Ordering Information

		,
FDD6030L FDD6030L D-PAK (TO-252) 13'	' 16mm	2500 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	urce Avalanche Ratings (Note	2)	_			
E _{AS}	Drain-Source Avalanche Energy	Single Pulse, $V_{DD} = 15 \text{ V}$, $I_D = 12 \text{ A}$			100	mJ
I _{AS}	Drain-Source Avalanche Current				12	Α
Off Char	acteristics		4			
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$		24		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, \qquad V_{GS} = 0 \text{ V}$			1	μA
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	1.9	3	V
$\Delta V_{GS(th)} \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A,Referenced to 25°C	<u> </u>	-5		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{ll} V_{GS} = 10 \ V, & I_D = 12 \ A \\ V_{GS} = 4.5 \ V, & I_D = 10 \ A \\ V_{GS} = 10 \ V, & I_D = 12 \ A, T_J = 125^\circ C \end{array} $		7.7 9.9 11.4	14.5 21 25	mΩ
I _{D(on)}	On–State Drain Current	$V_{GS} = 10 \text{ V}, \qquad V_{DS} = 5 \text{ V}$	50			Α
g _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \qquad I_D = 12 \text{ A}$		47		S
Dynamic	Characteristics				_	_
C _{iss}	Input Capacitance			1230		pF
C _{oss}	Output Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		325		pF
C _{rss}	Reverse Transfer Capacitance	f = 1.0 MHz		150		pF
R _G	Gate Resistance	$V_{GS} = 15 \text{ mV}, \text{ f} = 1.0 \text{ MHz}$		1.5		pF
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time			10	19	ns
tr	Turn–On Rise Time	$V_{DD} = 15 V, I_D = 1 A,$		7	13	ns
t _{d(off)}	Turn–Off Delay Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		29	46	ns
t _f	Turn–Off Fall Time	1		12	21	ns
Qg	Total Gate Charge			13	28	nC
Q _{gs}	Gate-Source Charge	$V_{DS} = 15V$, $I_D = 12 A$, $V_{GS} = 5 V$		3.5		nC
Q _{qd}	Gate-Drain Charge	VGS - V .	Γ	5.1		nC

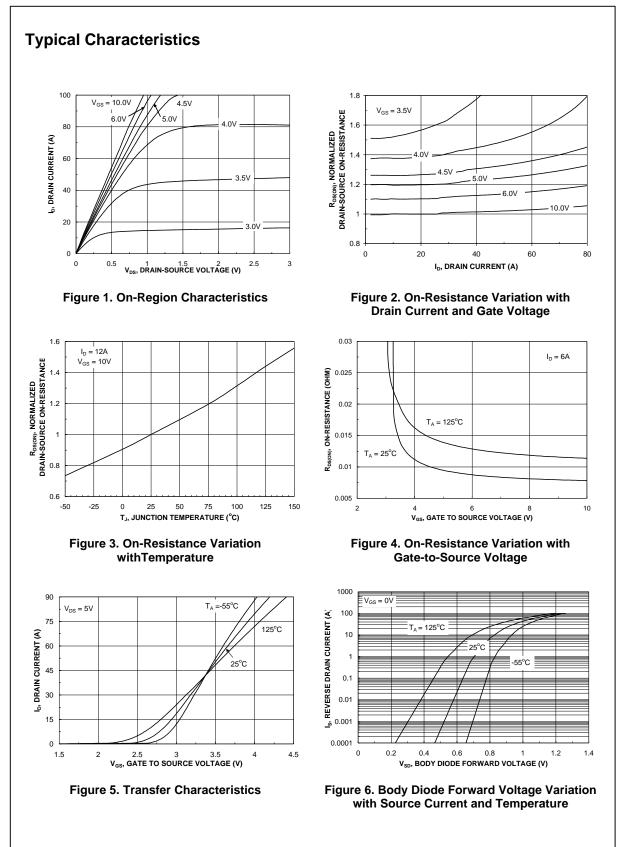
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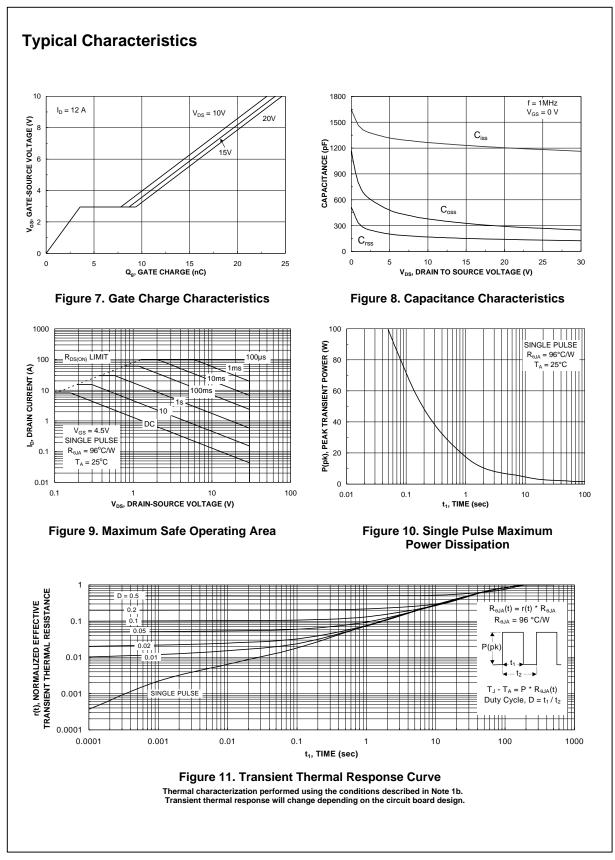
Symbol	ol Parameter Test Conditions		Min	Тур	Max	Units
Drain-So	urce Diode Characteristics an	d Maximum Ratings			•	
I _s	Maximum Continuous Drain–Source D				2.7	А
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \ V, I_S = 2.7 \ A \qquad (\text{Note 2})$		0.76	1.2	V
t _{rr}	Diode Reverse Recovery Time	$I_F = 12 \text{ A}, d_{iF}/d_t = 100 \text{ A}/\mu\text{s}$		24		nS
Q _{rr}	Diode Reverse Recovery Charge	1		13		nC
. $R_{\theta JA}$ is the sum the drain pins.	of the junction-to-case and case-to-ambient thermal r R_{BJC} is guaranteed by design while $R_{\theta CA}$ is determined a) $R_{\theta JA} = 45^{\circ}C/W$ wh	d by the user's board design. en mounted on a	b) R _{0JA}	= 96°C/W	when moun	
	1in ² pad of 2 oz co		on a	minimum p	oad.	
Pulse Test: Pul	se Width < 300µs, Duty Cycle < 2.0%	Scale 1 : 1 on letter size paper				
. Maximum curr	ent is calculated as: $\sqrt{\frac{P_D}{R_{DS(ON)}}}$					

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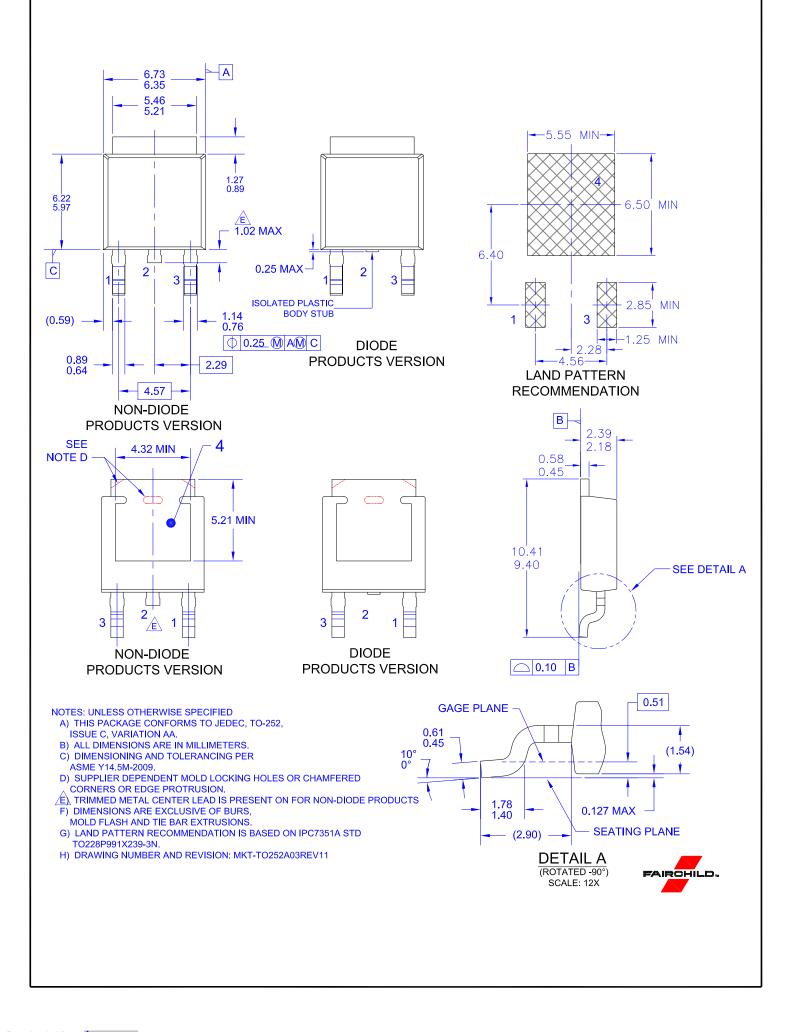


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